

FDPC5018SG

PowerTrench[®] Power Clip 30V Asymmetric Dual N-Channel MOSFET

Features

Q1: N-Channel

- Max $r_{DS(on)} = 5.0 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 17 \text{ A}$
- Max $r_{DS(on)}$ = 6.5 m Ω at V_{GS} = 4.5 V, I_D = 14 A

Q2: N-Channel

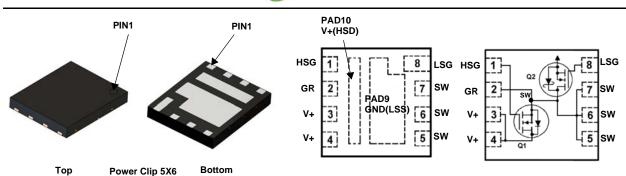
- Max $r_{DS(on)}$ = 1.6 m Ω at V_{GS} = 10 V, I_D = 32 A
- Max $r_{DS(on)}$ = 2.0 m Ω at V_{GS} = 4.5 V, I_D = 28 A
- Low Inductance Packaging Shortens Rise/Fall Times, Resulting in Lower Switching Losses
- MOSFET Integration Enables Optimum Layout for Lower Circuit Inductance and Reduced Switch Node Ringing
- RoHS Compliant

General Description

This device includes two specialized N-Channel MOSFETs in a dual package. The switch node has been internally connected to enable easy placement and routing of synchronous buck converters. The control MOSFET (Q1) and synchronous SyncFETTM (Q2) have been designed to provide optimal power efficiency.

Applications

- Computing
- Communications
- General Purpose Point of Load



Pin	Name	Description	Pin	Name	Description	Pin	Name	Description
1	HSG	High Side Gate	3,4,10	V+(HSD)	High Side Drain	8	LSG	Low Side Gate
2	GR	Gate Return	5,6,7	SW	Switching Node, Low Side Drain	9	GND(LSS)	Low Side Source

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Parameter			Q2	Units	
V _{DS}	Drain to Source Voltage			30	V	
Bvdsst	Bvdsst (transient) < 100nS			32.5	V	
V _{GS}	Gate to Source Voltage			±12	V	
	Drain Current -Continuous	T _C = 25 °C (Note 5)	56	109		
	-Continuous	T _C = 100 °C (Note 5)	35	69		
D	-Continuous	T _A = 25 °C	17 ^{Note1a}	32 ^{Note1b}	A	
	-Pulsed	T _A = 25 °C (Note 4)	227	704		
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	54	181	mJ	
	Power Dissipation for Single Operation T		23	29		
P _D	Power Dissipation for Single Operation	T _A = 25 °C	2.1 ^{Note1a}	2.3 ^{Note1b}	W	
	Power Dissipation for Single Operation	T _A = 25 °C	1.0 ^{Note1c}	1.1 ^{Note1d}	1	
T _J , T _{STG}	Operating and Storage Junction Temperature Range -55 to +150				°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	5.6	4.3	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	60 ^{Note1a}	55 ^{Note1b}	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	130 ^{Note1c}	120 ^{Note1d}	

Device Marking		Device	Package Reel Size		Tape Width			Quantity	
FDPC5018SG FI		FDPC5018SG	Power Clip 56 13 "		12 mm			3000 units	
Electric	al Chara	cteristics T _J = 25 °C	unless otherwise not	ed.					
Symbol		Parameter	Test Con		Туре	Min	Тур	Max	Units
Off Chara	acteristics								
BV _{DSS}	Drain to Sc	ource Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = I_D = 1 \ mA, \ V_{GS} = 0$		Q1 Q2	30 30			V
ΔBV _{DSS} ΔT.I	Breakdown Coefficient	Noltage Temperature	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ m$ A, referenced to 25 °C		Q1 Q2		15 19		mV/°C
I _{DSS}	Zero Gate	Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$ $V_{DS} = 24 V, V_{GS} = 0 V$		Q1 Q2			1 500	μΑ μΑ
I _{GSS}	Gate to Source Leakage Current, Forward			V _{GS} = 20 V, V _{DS} = 0 V				100 100	nA nA
On Chara	cteristics				11		1		I
V _{GS(th)}		urce Threshold Voltage	$V_{GS} = V_{DS}, I_D = 2$ $V_{GS} = V_{DS}, I_D = 1$		Q1 Q2	1.0 1.0	1.7 1.6	3.0 3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{II}}$		urce Threshold Voltage re Coefficient	$I_D = 250 \ \mu\text{A}, \text{ refere}$ $I_D = 10 \ \text{mA}, \text{ refere}$	nced to 25 °C	Q1 Q2	1.0	-5 -3	0.0	mV/°C
			$V_{GS} = 10V, I_D = 17$ $V_{GS} = 4.5 V, I_D = 1$ $V_{GS} = 10 V, I_D = 1$	A 4 A	Q1		4.1 5.4 5.7	5.0 6.5 7.0	
r _{DS(on)}	Drain to Sc	ource On Resistance	$V_{GS} = 10V, I_D = 32$ $V_{GS} = 4.5 V, I_D = 2$ $V_{GS} = 10 V, I_D = 32$	A 8 A	Q2		1.4 1.7 2.1	1.6 2.0 2.4	mΩ
9fs	Forward Tr	ansconductance	$V_{DS} = 5 V, I_D = 17$ $V_{DS} = 5 V, I_D = 32$		Q1 Q2		93 188		S
Dvnamic	Character	ristics							
C _{iss}	Input Capa		Q1: V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHZ		Q1 Q2		1224 4593	1715 6430	pF
C _{oss}	Output Cap	bacitance			Q1 Q2		397 1210	560 1695	pF
C _{rss}	Reverse Tr	ansfer Capacitance	Q2: V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHZ		Q1 Q2		42 80	60 115	pF
R _g	Gate Resistance				Q1 Q2	0.1 0.1		1.5 2.4	Ω
Switching	g Characte	eristics							
t _{d(on)}	Turn-On De				Q1 Q2		8 14	16 25	ns
t _r	Rise Time		Q1: V _{DD} = 15 V, I _D = 1	7 A, R _{GEN} = 6 Ω	Q1 Q2		2	10 10	ns
t _{d(off)}	Turn-Off De	elay Time	Q2: V _{DD} = 15 V, I _D = 32 A, R _{GEN} = 6 Ω		Q1 Q2		18 38	33 61	ns
t _f	Fall Time				Q1 Q2		2 4	10 10	ns
Qg	Total Gate	Charge	$V_{GS} = 0 V$ to 10 V	Q1	Q1 Q2		17 62	24 87	nC
Qg	Total Gate	Charge	$V_{GS} = 0 V$ to 4.5 V		Q1 Q2		8 28	11 40	nC
Q _{gs}	Gate to So	urce Gate Charge		Q2 V _{DD} = 15 V, I _D	Q1 Q2		3.1 11		nC
Q _{gd}	Gate to Dra	ain "Miller" Charge		= 32 A			2.0 5.3		nC

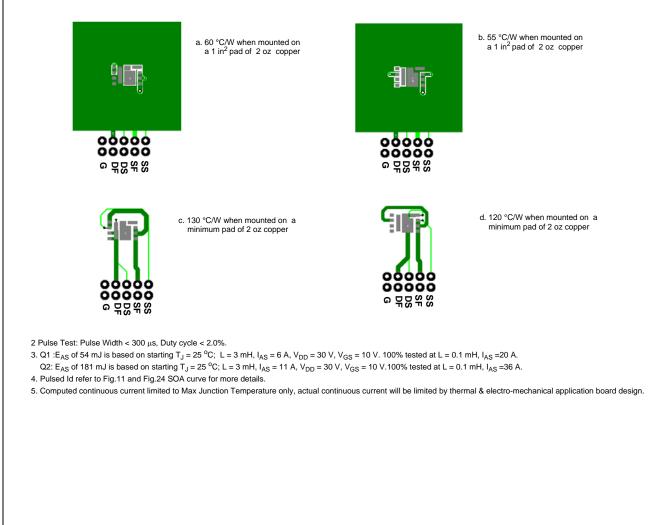
Package Marking and Ordering Information

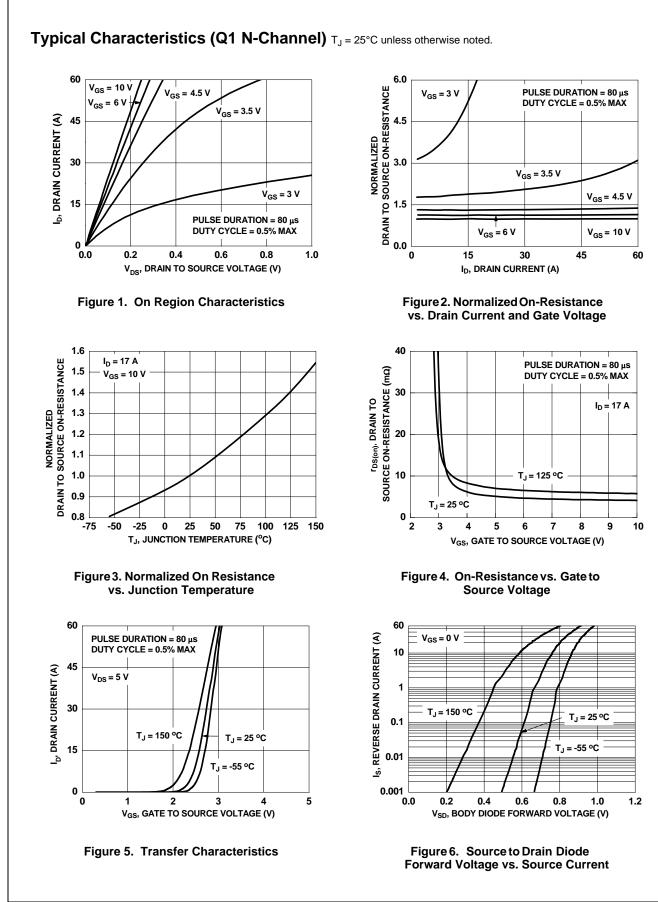
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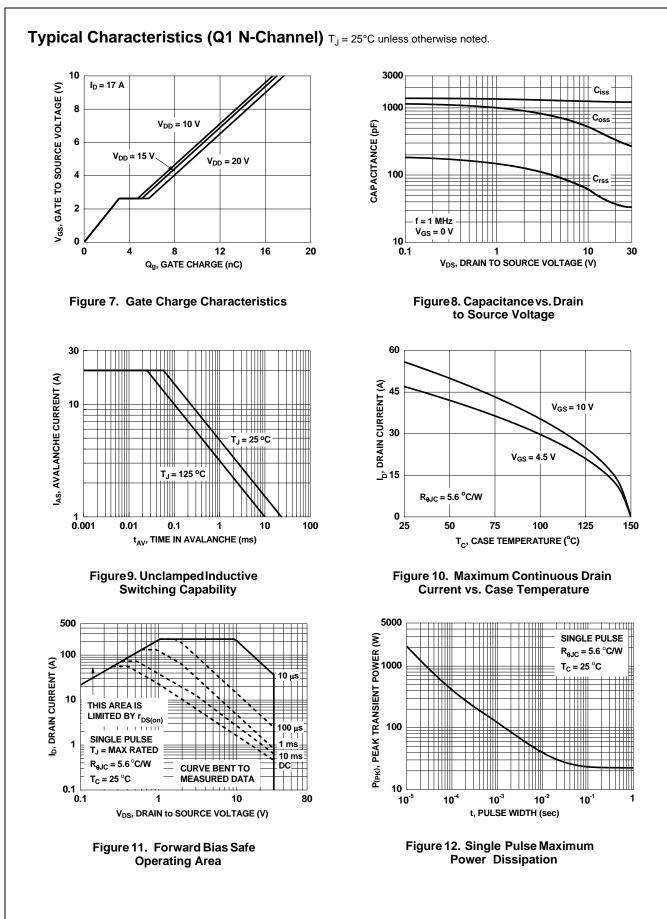
Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Drain-Sou	Irce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage		Q1 Q2		0.8 0.8	1.2 1.2	V
t _{rr}	Reverse Recovery Time	Q1 I _F = 17 A, di/dt = 100 A/μs	Q1 Q2		23 32	37 51	ns
Q _{rr}	Reverse Recovery Charge	Q2 I _F = 32 A, di/dt = 240 A/μs	Q1 Q2		8 40	16 64	nC

Notes:

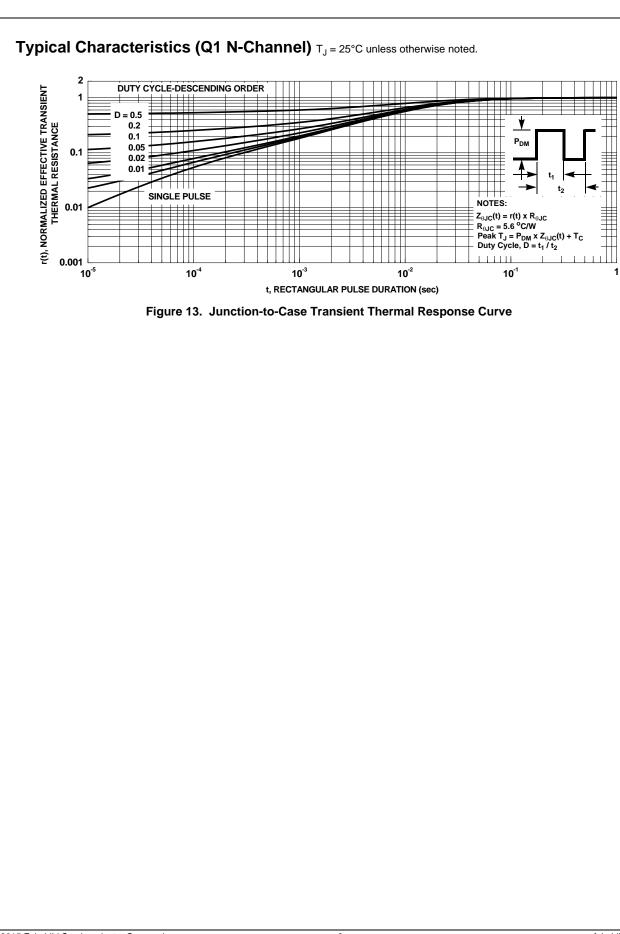
 $1.R_{0,LA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material, $R_{0,CA}$ is determined by the user's board design.

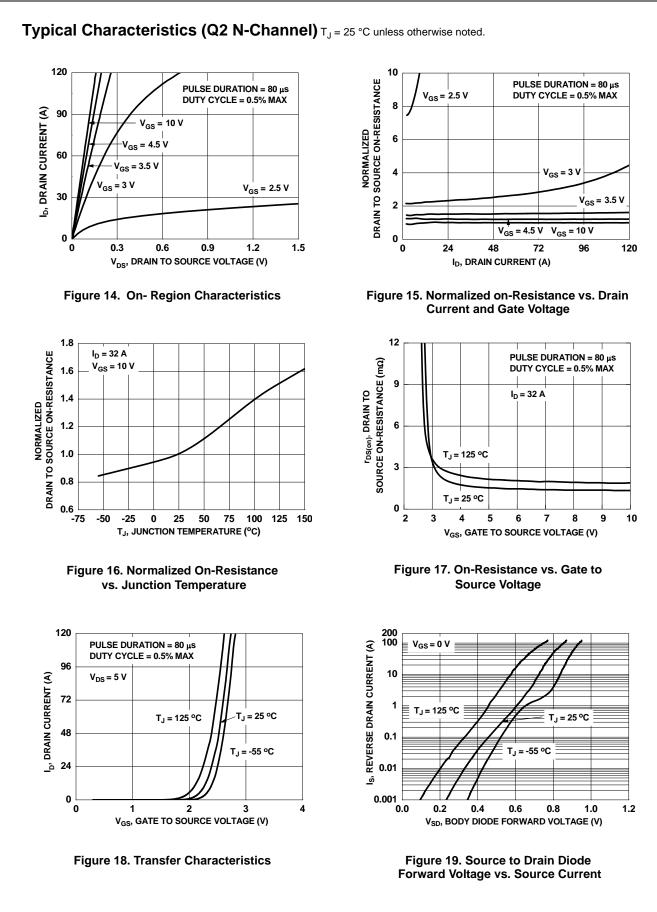


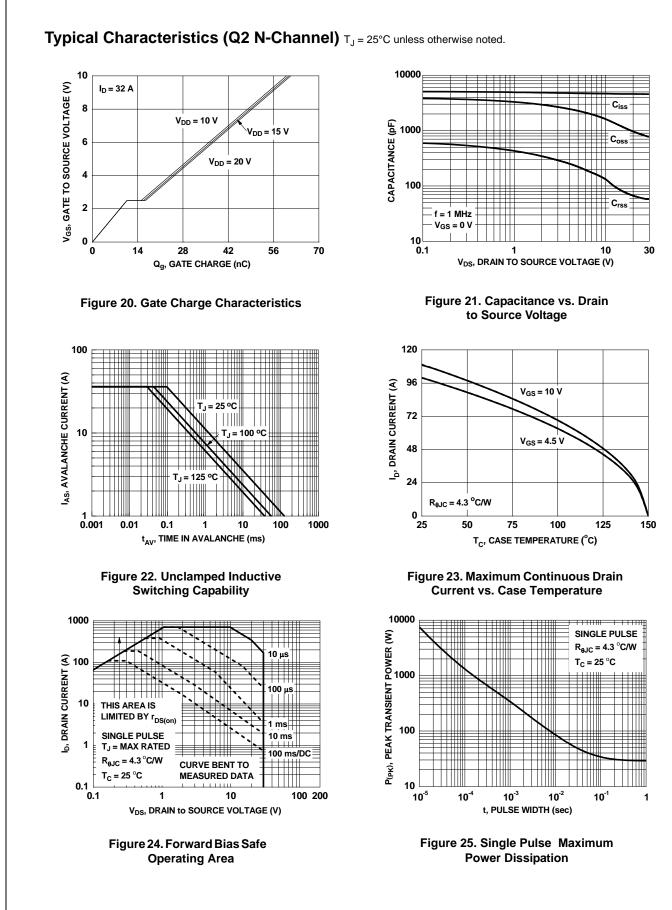




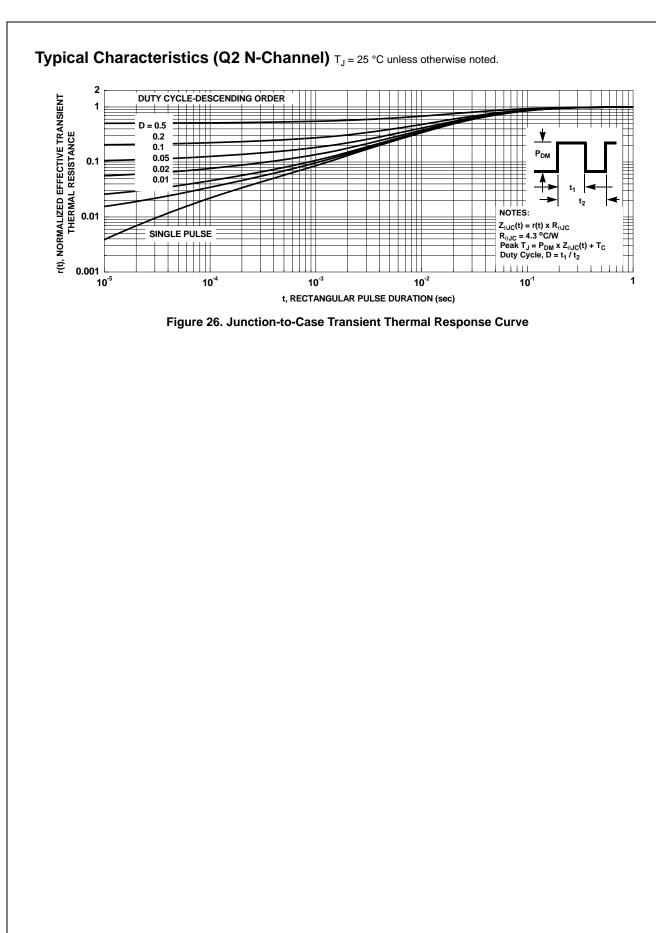












Typical Characteristics (continued)

SyncFET[™] Schottky Body Diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench[®] MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 27 shows the reverse recovery characteristic of the FDPC5018SG.

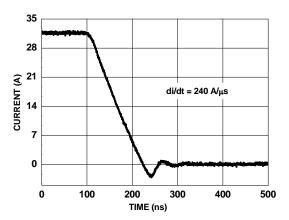
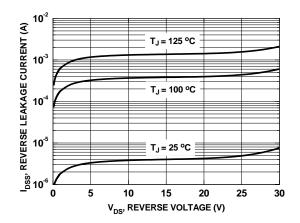
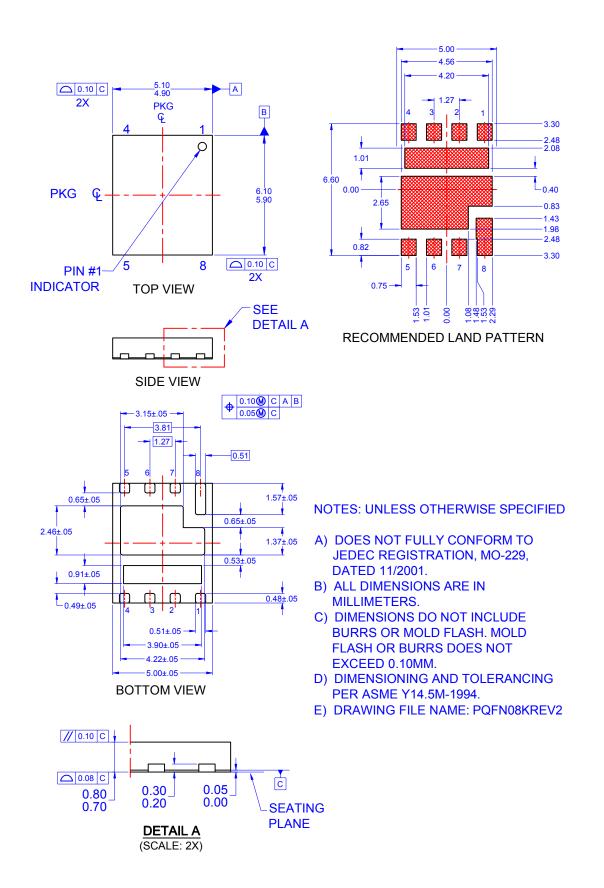


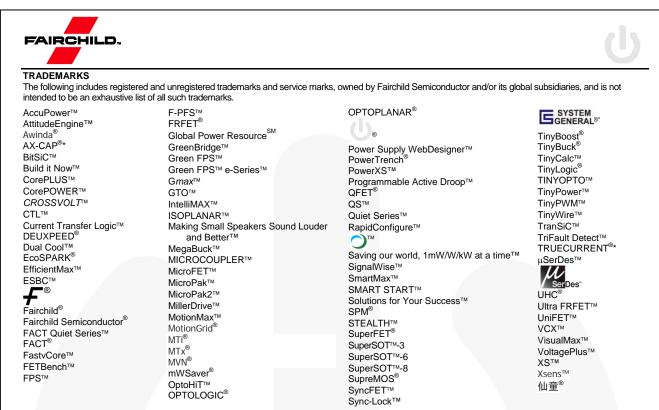
Figure 27. FDPC5018SG SyncFET[™] Body Diode Reverse Recovery Characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.









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